

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT5716454

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
PAWEL BUJNOWSKI	08/02/2019
DAWID WISNIEWSKI	08/13/2019
HEE SIK JEON	08/02/2019
JOANNA EWA MARHULA	08/02/2019
KATARZYNA BEKSA	08/02/2019
MACIEJ ZEMBRZUSKI	08/06/2019
RECEIVING PARTY DATA	
Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU
City:	SUWON-SI, GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	16677
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16493667
CORRESPONDENCE DATA	
Fax Number:	(972)628-3616
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Email:	patents@munckwilson.com
Correspondent Name:	DOCKET CLERK - SEC
Address Line 1:	P.O. DRAWER 800889
Address Line 4:	DALLAS, TEXAS 75380
ATTORNEY DOCKET NUMBER:	SAMS06-18076
NAME OF SUBMITTER:	JACOB L. LACOMBE
SIGNATURE:	/Jacob L. LaCombe, Reg. #63,036/
DATE SIGNED:	09/12/2019
Total Attachments: 5	

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ASSIGNMENT

WHEREAS, We, Pawel BUJNOWSKI, resident of Warszawa, Poland, Dawid WISNIEWSKI, resident of Wagrowiec, Poland, Hee Sik JEON, resident of Yongin-si, Gyeonggi-do, Republic of Korea, Joanna Ewa MARHULA, resident of Warszawa, Poland, Katarzyna BEKSA, resident of Kobylka, Poland, and Maciej ZEMBRZUSKI, resident of Poznan, Poland, have invented certain new and useful improvements in a "METHOD FOR PROCESSING LANGUAGE INFORMATION AND ELECTRONIC DEVICE THEREFOR" disclosed in an application for United States Letters Patent (Application Serial No. 16/493,667, filed on September 12, 2019), said application having been executed concurrently herewith;

WHEREAS, SAMSUNG ELECTRONICS CO., LTD., a corporation organized under the laws of the Republic of Korea, having a place of business at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea (hereinafter referred to as "ASSIGNEE"), is desirous of acquiring our entire right, title and interest in and to the invention, and in and to the said application and any Letters Patent that may issue thereon;


NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the full and exclusive right, title and interest in and to said invention and in and to said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, continuations-in-part and extensions thereof; We authorize William A. Munck of Munck Wilson Mandala, LLP to insert in the parenthesis above the application number and filing date of said application when known; and we hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patents resulting therefrom, insofar as our interest is concerned, to the said ASSIGNEE of our entire right, title and interest.

We also hereby sell and assign to said ASSIGNEE, its successors, assigns and legal representatives the full and exclusive rights, title and interest to the invention disclosed in said application throughout the world, including the right to file applications and obtain patents, utility models, industrial models and designs for said invention in its own name throughout the world including all rights of priority, all rights to publish cautionary notices reserving ownership of said invention and all rights to register said invention in appropriate registries; and we further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith necessary to perfect such rights, title and interest in ASSIGNEE, its successors, assigns and legal representatives.

We hereby further agree that we will communicate to said ASSIGNEE, or to its successors, assigns and legal representatives, any facts known to us respecting any improvements; and, at the

expense of said ASSIGNEE, to testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, continuation-in-part, revision and substitute applications, and make all lawful oaths, and generally do everything possible to vest title in said ASSIGNEE and to aid said ASSIGNEE, its successors, assigns and legal representatives to obtain and enforce proper protection for said invention in all countries.

Date: 2.08.2013


Pawel BUNIKOWSKI

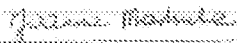
Date: _____

Borisl WENIEWSKI

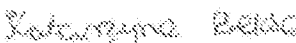
Date: _____

Bee SB JEON

Date: 02.07.2018


Joanna Ewa MARHUTA

Date: 2.08.2018


Katarzyna BERNA

Date: _____

Maciej ZEMBOZUSKI

expense of said ASSIGNEE, to testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, continuation-in-part, reissue and substitute applications, and make all lawful oaths, and generally do everything possible to vest title in said ASSIGNEE and to aid said ASSIGNEE, its successors, assigns and legal representatives to obtain and enforce proper protection for said invention in all countries.

Date: _____
Pawel BUJNOWSKI

Date: August 13, 2019
Wisniowski David
Dawid WISNIEWSKI

Date: _____
Hee Sik JEON

Date: _____
Joanna Ewa MARHULA

Date: _____
Katarzyna BEKSA

Date: _____
Maciej ZEMBRZUSKI

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Date: _____
Pawel BUJNOWSKI

Date: _____
Dawid WISNIEWSKI

Date: Aug. 3, 2019

Hee Sik JEON

Date: _____
Joanna Ewa MARHULA

Date: _____
Katarzyna BEKSA

Date: _____
Maciej ZEMBRZUSKI

expense of said ASSIGNEE, to testify in any legal proceedings, sign all lawful papers, execute all decisions, continuation, continuation-in-part, reissue and substitute applications, and make all lawful oaths, and generally do everything possible to vest title in said ASSIGNEE and in said ASSIGNEE, its successors, assigns and legal representatives to obtain and obtain proper protection for said invention in all countries.

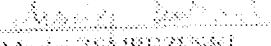
Date:
Paweł BUJNOWSKI

Date:
Dawid WISNIEWSKI

Date:
Heo Sik JEON

Date:
Eszter Eszter MARBUJA

Date:
Katarzyna DEKSA

Date: 11.06.2015

Maciej ZEMBRZUSKI